## 503054013 11/10/2014

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SUNGHOON JUNG	09/17/2014
YOUNGDAE LEE	09/17/2014
SUNGJUN PARK	09/17/2014
SEUNGJUNE YI	09/17/2014
JAEWOOK LEE	09/17/2014

#### **RECEIVING PARTY DATA**

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## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14399843

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NAME OF SUBMITTER:	TAN TU
SIGNATURE:	/Tu T. Tan/
DATE SIGNED:	11/07/2014

**Total Attachments: 2** 

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ATTORNEY DOCKET NO.: 5438-0610PUS1

# BIRCH, STEWART, KOLASCH & BIRCH, LLP

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## ASSIGNMENT

Application No.	14/399,843	Filed	November 07, 2014		
Insert Name(s) of Inventor(s)	***(Given Name FAMILY NAME (ALL CAPS))***				
o	WHEREAS, JUNG, Sunghoon; LEE, Jaewook (hereinafter designated as the unimprovements in:				
Insert Title of Invention	METHOD FOR REPORTING INFORM ESTIMATING LOCATION IN WIRELE SUPPORTING SAME		LOCATION ESTIMATION AND ION SYSTEM, AND APPARATUS FOR		
	for which an application for Letters Pate undersigned (except in the case of a prov		tes of America has been executed by the		
Insert Date of Signing of	onSeptember 17, 2014		; and		
Application Insert Name	WHEREAS, LG ELECTRONICS INC.				
of Assignee Insert Address of Assignee	of 20 Yeouido-dong Yeongdeungpo-gu S	Seoul 150-721 Repub	lic of Korea		
CHECK BOX IF APPROPRIATE		e and interest in and t	reinafter designated as the Assignee) is to said invention and in and to any Letters America and		
IF AFFROPALATE	paid, the receipt of which is hereby ac undersigned has (have) sold, assigned transfer unto said Assignee the full and America, its territories, dependencies an any and all Letters Patent(s) which man	knowledged, and oth and transferred, and exclusive right to the d possessions and the ay be granted theref	ollars (\$10.00) to the undersigned in hand her good and valuable consideration, the by these presents does sell, assign and he said invention in the United States of he entire right, title and interest in and to for in the United States of America, its love is designated, in any and all foreign		
	and to any and all divisions, reissues, of term or terms for which the same may be		sions and extensions thereof for the full		
	The undersigned agree(s) to execute all	papers necessary in	connection with this application and any		

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in

may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining

The undersigned agree (s) to execute all papers necessary in connection with any interference which

connection with such applications as the Assignee may deem necessary or expedient.

Page 1 of 2

and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date Sept. 17, 2014	Name of Inventor (signature) JUNG, Sunghoon
Date Sept. 17, 2014	Name of Inventor (signature) LEE, Youngdae
Sept. 17, 2014 <sub>.</sub>	Name of Inventor Sung In Park - GA
Date Sept. 17, 2014	(signature) PARK, Sungjun  Name of Inventor
Date Sept. 17, 2014	(signature) YI, Seungjune  TagWook Lee  (signature) LEE, Jaewook

**RECORDED: 11/10/2014**